



ALPHA & OMEGA
SEMICONDUCTOR, LTD.

Rev 1: June 2004

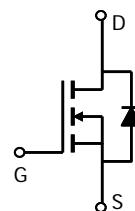
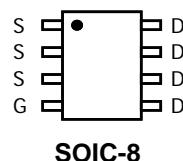
AO4430, AO4430L (Green Product) N-Channel Enhancement Mode Field Effect Transistor

General Description

The AO4430 uses advanced trench technology to provide excellent $R_{DS(ON)}$, shoot-through immunity, body diode characteristics and ultra-low gate resistance. This device is ideally suited for use as a low side switch in Notebook CPU core power conversion. AO4430L (Green Product) is offered in a lead free package.

Features

V_{DS} (V) = 30V
 I_D = 18A
 $R_{DS(ON)} < 5.5\text{m}\Omega$ ($V_{GS} = 10\text{V}$)
 $R_{DS(ON)} < 7.5\text{m}\Omega$ ($V_{GS} = 4.5\text{V}$)



Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ^A	I_D	18	A
$T_A=70^\circ\text{C}$		15	
Pulsed Drain Current ^B	I_{DM}	80	
Power Dissipation	P_D	3	W
$T_A=70^\circ\text{C}$		2.1	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A	$R_{\theta JA}$	31	40	°C/W
Steady-State		59	75	°C/W
Maximum Junction-to-Lead ^C	$R_{\theta JL}$	16	24	°C/W

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	30			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=24\text{V}, V_{GS}=0\text{V}$ $T_J=55^\circ\text{C}$		1		μA
				5		
I_{GSS}	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$			100	nA
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1	1.8	2.5	V
$I_{D(\text{ON})}$	On state drain current	$V_{GS}=4.5\text{V}, V_{DS}=5\text{V}$	80			A
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=18\text{A}$ $T_J=125^\circ\text{C}$		4.7	5.5	$\text{m}\Omega$
			6.5	8		
		$V_{GS}=4.5\text{V}, I_D=15\text{A}$		6.2	7.5	$\text{m}\Omega$
g_{FS}	Forward Transconductance	$V_{DS}=5\text{V}, I_D=18\text{A}$		82		S
V_{SD}	Diode Forward Voltage	$I_S=1\text{A}, V_{GS}=0\text{V}$		0.7	1	V
I_S	Maximum Body-Diode Continuous Current				4.5	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=15\text{V}, f=1\text{MHz}$		6060		pF
C_{oss}	Output Capacitance			638		pF
C_{rss}	Reverse Transfer Capacitance			355		pF
R_g	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$		0.45		Ω
SWITCHING PARAMETERS						
$Q_g(10\text{V})$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=15\text{V}, I_D=18\text{A}$		103		nC
$Q_g(4.5\text{V})$	Total Gate Charge			48		nC
Q_{gs}	Gate Source Charge			18		nC
Q_{gd}	Gate Drain Charge			15		nC
$t_{D(\text{on})}$	Turn-On Delay Time	$V_{GS}=10\text{V}, V_{DS}=15\text{V}, R_L=0.83\Omega, R_{\text{GEN}}=3\Omega$		12		ns
t_r	Turn-On Rise Time			8		ns
$t_{D(\text{off})}$	Turn-Off Delay Time			51.5		ns
t_f	Turn-Off Fall Time			8.8		ns
t_{rr}	Body Diode Reverse Recovery Time	$I_F=18\text{A}, dI/dt=100\text{A}/\mu\text{s}$		33.5		ns
Q_{rr}	Body Diode Reverse Recovery Charge	$I_F=18\text{A}, dI/dt=100\text{A}/\mu\text{s}$		22		nC

A: The value of R_{0JA} is measured with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The value in any given application depends on the user's specific board design. The current rating is based on the $\leq 10\text{s}$ thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

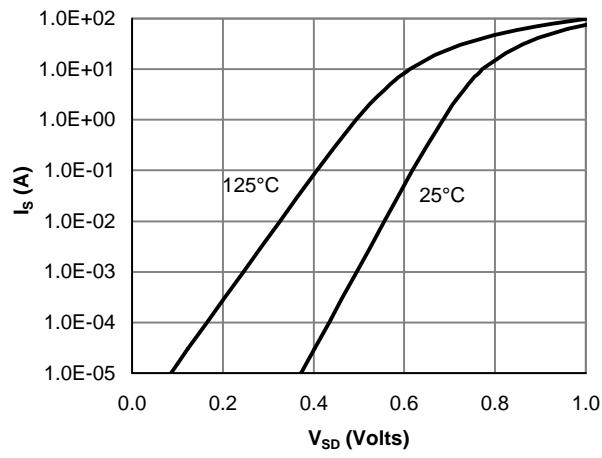
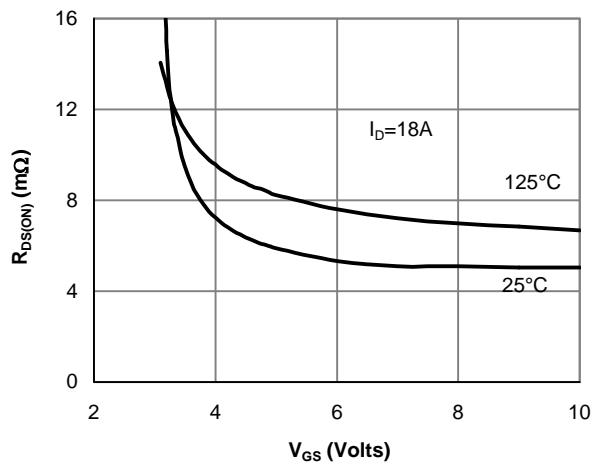
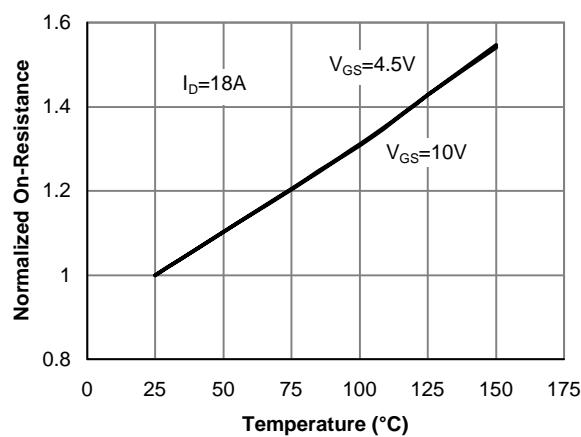
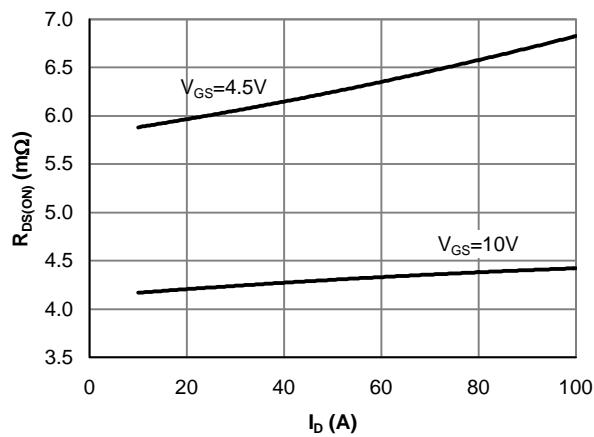
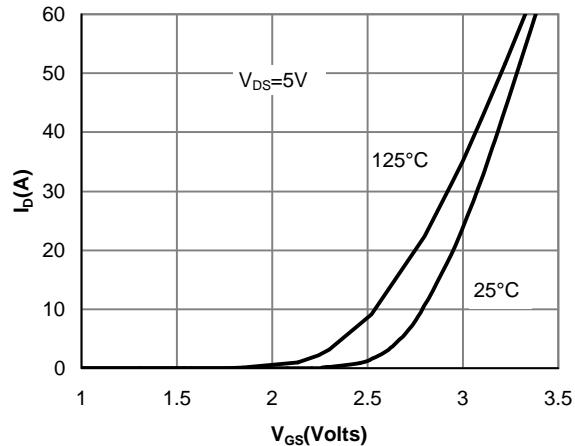
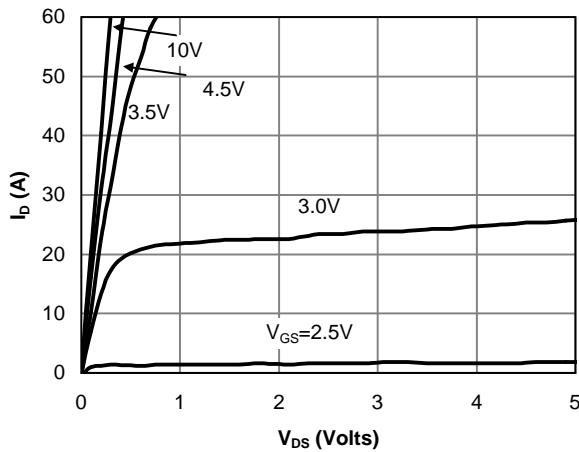
C. The R_{0JA} is the sum of the thermal impedance from junction to lead R_{0JL} and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using 80 μs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The SOA curve provides a single pulse rating.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



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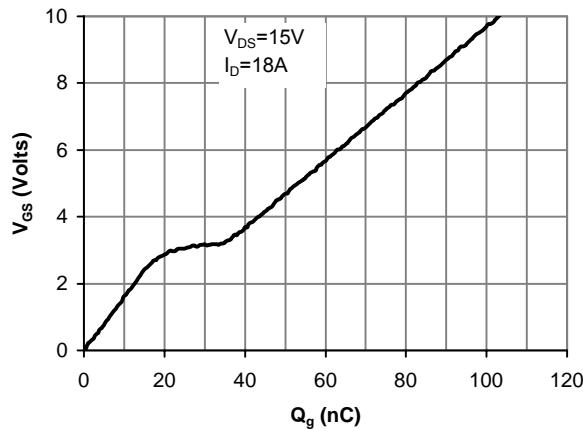


Figure 7: Gate-Charge Characteristics

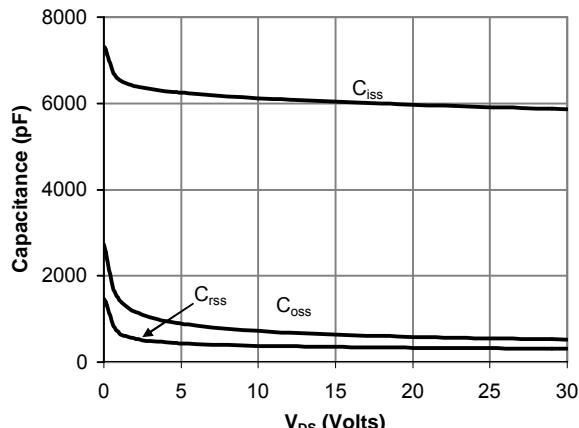


Figure 8: Capacitance Characteristics

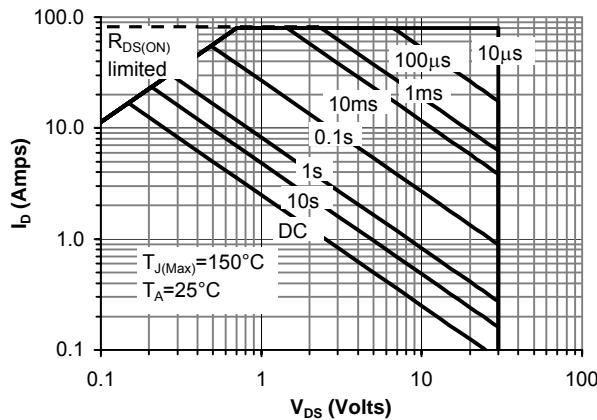


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

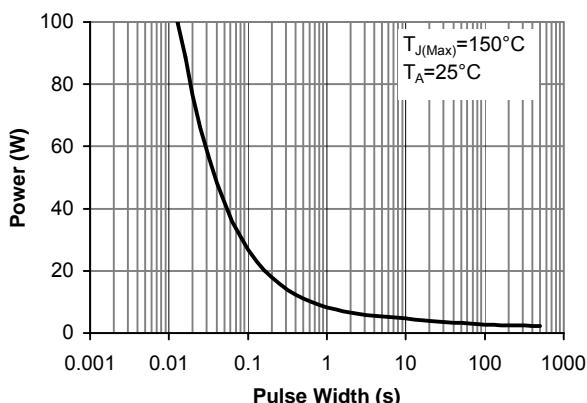


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

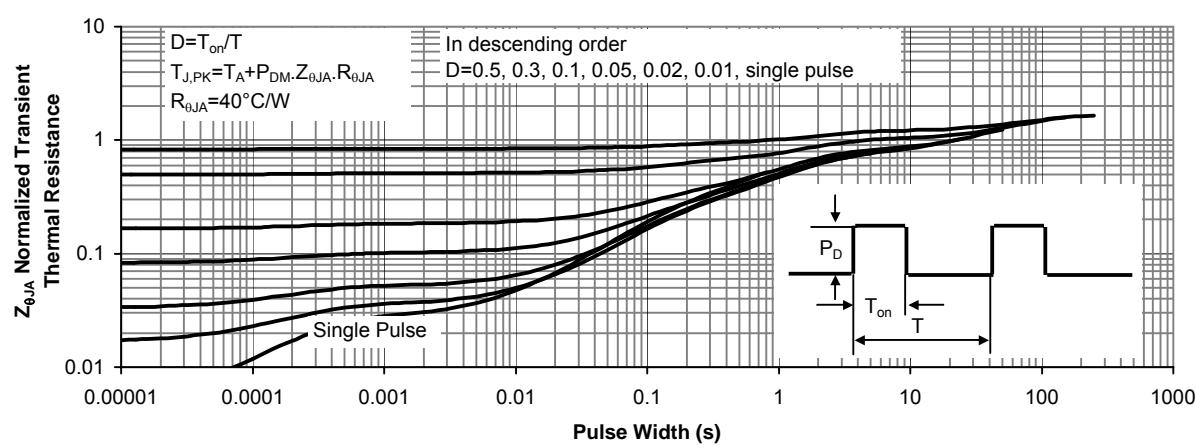


Figure 11: Normalized Maximum Transient Thermal Impedance